

2MBI600VJ-120-50

IGBT Modules

IGBT MODULE (V series) 1200V / 600A / 2 in one package

■ Features

- High speed switching
- Voltage drive
- Low Inductance module structure

■ Applications

- Inverter for Motor Drive
- AC and DC Servo Drive Amplifier
- Uninterruptible Power Supply
- Industrial machines, such as Welding machines



■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items	Symbols	Conditions	Maximum ratings	Units	
Inverter	Collector-Emitter voltage	V_{CES}	1200	V	
	Gate-Emitter voltage	V_{GES}	±20	V	
	Collector current	I_c	Continuous	Tc=25°C 750 Tc=100°C 600	A
			Ic pulse	1ms	
		-Ic		600	
		-Ic pulse	1ms	1200	
Collector power dissipation	P_c	1 device	3750	W	
Junction temperature	T_j		175	°C	
Operating junction temperature (under switching conditions)	T_{jop}		150		
Case temperature	T_c		125		
Storage temperature	T_{stg}		-40 to +125		
Isolation voltage	between terminal and copper base (*1) between thermistor and others (*2)	V_{iso}	AC : 1min.	VAC	
Screw torque	Mounting (*3)		3.5	N m	
	Terminals (*4)		4.5		
	PC-Board (*5)		0.6		

Note *1: All terminals should be connected together during the test.

Note *2: Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

Note *3: Recommendable value : 2.5-3.5 Nm (M5) Note *4: Recommendable value : 3.5-4.5 Nm (M6)

Note *5: Recommendable value : 0.4-0.6 Nm (M2.5)

● Electrical characteristics (at Tj= 25°C unless otherwise specified)

Items	Symbols	Conditions	Characteristics			Units	
			min.	typ.	max.		
Zero gate voltage collector current	I_{CES}	$V_{GE} = 0V, V_{CE} = 1200V$	-	-	3.0	mA	
Gate-Emitter leakage current	I_{GES}	$V_{CE} = 0V, V_{GE} = \pm 20V$	-	-	600	nA	
Gate-Emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = 20V, I_c = 600mA$	6.0	6.5	7.0	V	
Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal)	$V_{GE} = 15V$ $I_c = 600A$	Tj=25°C	-	2.45	2.90	V
			Tj=125°C	-	2.80	-	
			Tj=150°C	-	2.85	-	
	$V_{CE(sat)}$ (chip)		Tj=25°C	-	1.85	2.30	
			Tj=125°C	-	2.20	-	
			Tj=150°C	-	2.25	-	
Internal gate resistance	$R_{g(int)}$	-	-	1.25	-	Ω	
Input capacitance	C_{ies}	$V_{CE} = 10V, V_{GE} = 0V, f = 1MHz$	-	48	-	nF	
Turn-on time	t_{on}	$V_{CC} = 600V$	-	550	-	nsec	
	t_r	$I_c = 600A$	-	180	-		
	$t_r(i)$	$V_{GE} = \pm 15V$	-	120	-		
	t_{off}	$R_g = 0.62\Omega$	-	1050	-		
Turn-off time	t_f	$L_s = 80nH$	-	110	-		
			-	-	-		
Forward on voltage	V_F (terminal)	$V_{GE} = 0V$ $I_F = 600A$	Tj=25°C	-	2.30	2.75	V
			Tj=125°C	-	2.45	-	
			Tj=150°C	-	2.40	-	
	V_F (chip)		Tj=25°C	-	1.70	2.15	
			Tj=125°C	-	1.85	-	
			Tj=150°C	-	1.80	-	
Reverse recovery time	t_{rr}	$I_F = 600A$	-	200	-	nsec	
Resistance	R	T=25°C	-	5000	-	Ω	
		T=100°C	465	495	520		
B value	B	T=25/50°C	3305	3375	3450	K	

● Thermal resistance characteristics

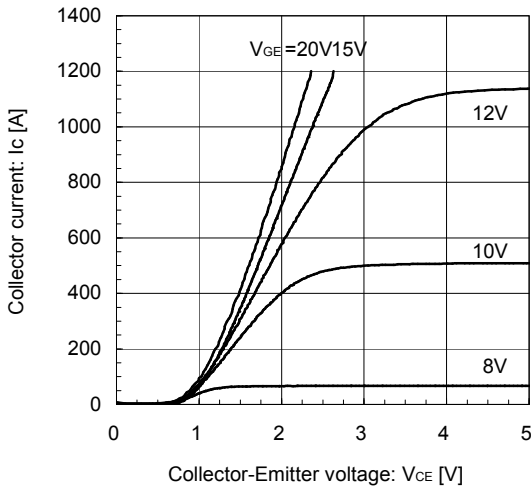
Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal resistance (1device)	Rth(j-c)	Inverter IGBT	-	-	0.04	°C/W
		Inverter FWD	-	-	0.06	
Contact thermal resistance (1device) (*6)	Rth(c-f)	with Thermal Compound	-	0.0167	-	

Note *6: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Characteristics (Representative)

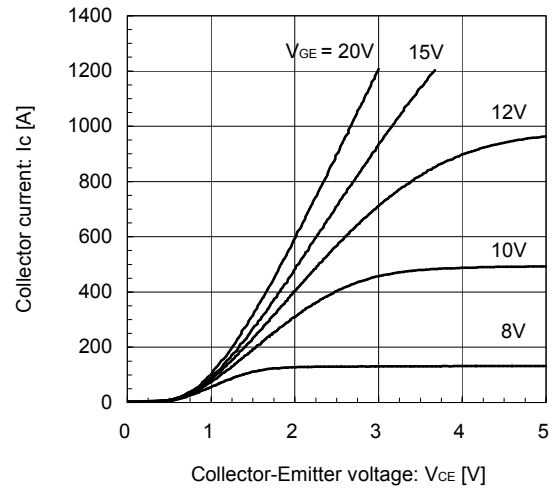
[INVERTER]

Collector current vs. Collector-Emmitter voltage (typ.)
Tj= 25°C / chip



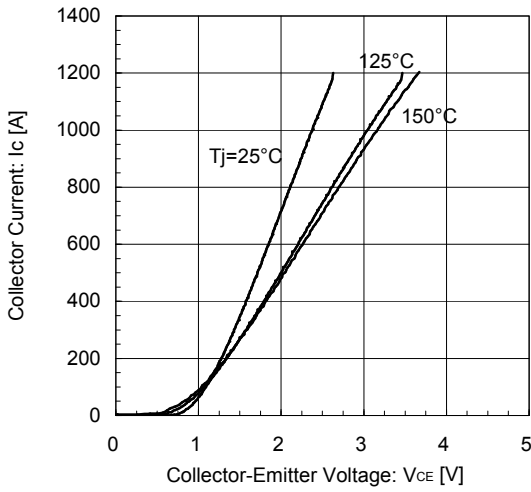
[INVERTER]

Collector current vs. Collector-Emmitter voltage (typ.)
Tj= 150°C / chip



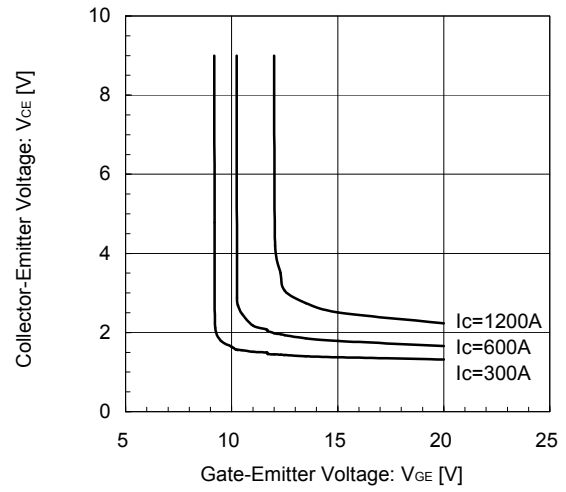
[INVERTER]

Collector current vs. Collector-Emmitter voltage (typ.)
VGE= 15V / chip



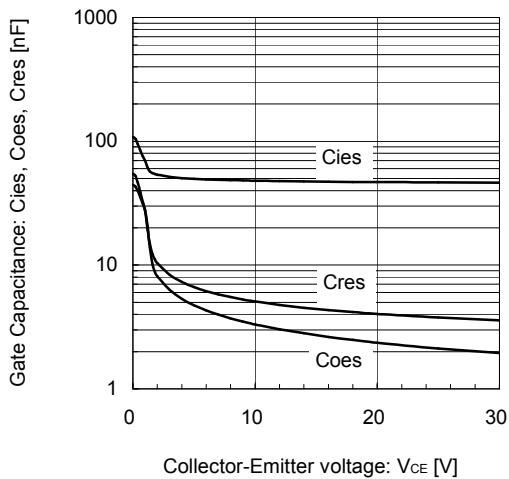
[INVERTER]

Collector-Emmitter voltage vs. Gate-Emmitter voltage (typ.)
Tj= 25°C / chip



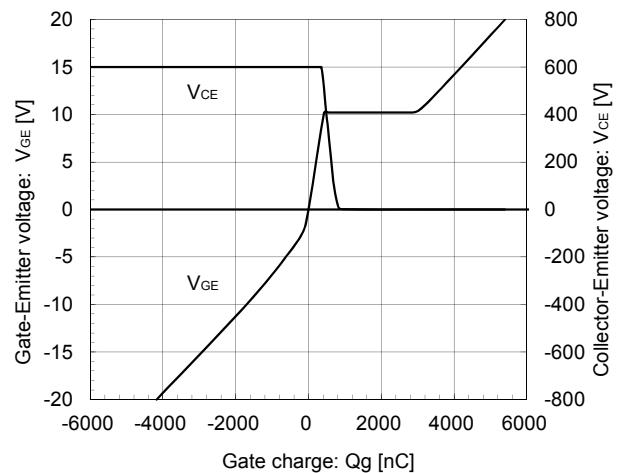
[INVERTER]

Gate Capacitance vs. Collector-Emmitter Voltage (typ.)
VGE= 0V, f= 1MHz, Tj= 25°C



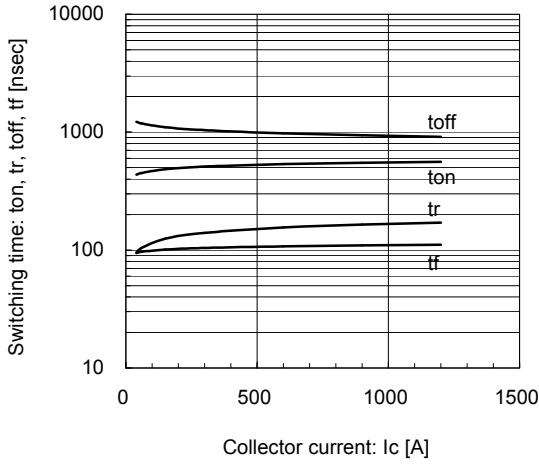
[INVERTER]

Dynamic Gate Charge (typ.)
Vcc=600V, Ic=600A, Tj= 25°C



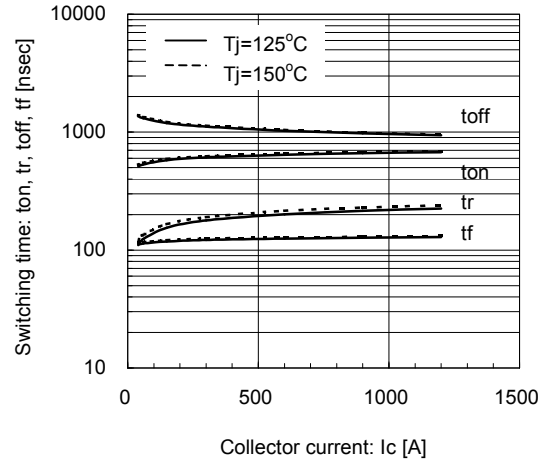
[INVERTER]

Switching time vs. Collector current (typ.)
 $V_{CC}=600V, V_{GE}=\pm 15V, R_g=0.62\Omega, T_j=25^\circ C$



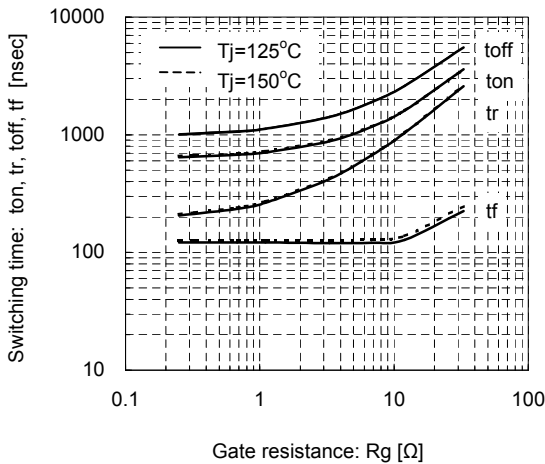
[INVERTER]

Switching time vs. Collector current (typ.)
 $V_{CC}=600V, V_{GE}=\pm 15V, R_g=0.62\Omega, T_j=125^\circ C, 150^\circ C$



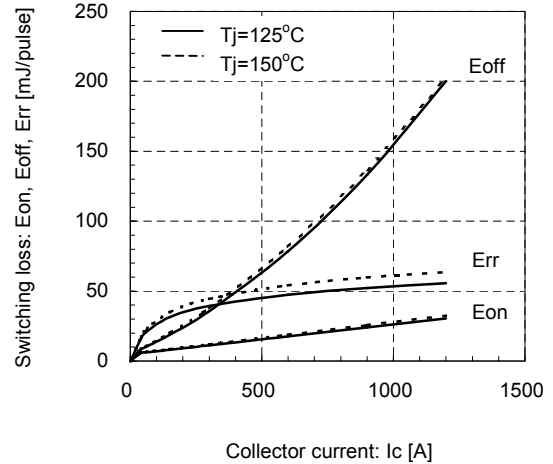
[INVERTER]

Switching time vs. Gate resistance (typ.)
 $V_{CC}=600V, I_c=600A, V_{GE}=\pm 15V, T_j=125^\circ C, 150^\circ C$



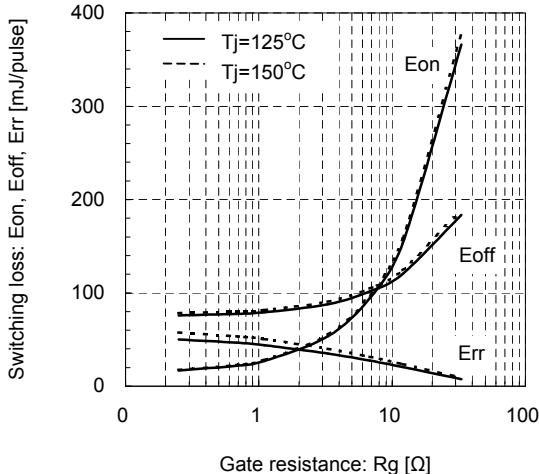
[INVERTER]

Switching loss vs. Collector current (typ.)
 $V_{CC}=600V, V_{GE}=\pm 15V, R_g=0.62\Omega, T_j=125^\circ C, 150^\circ C$



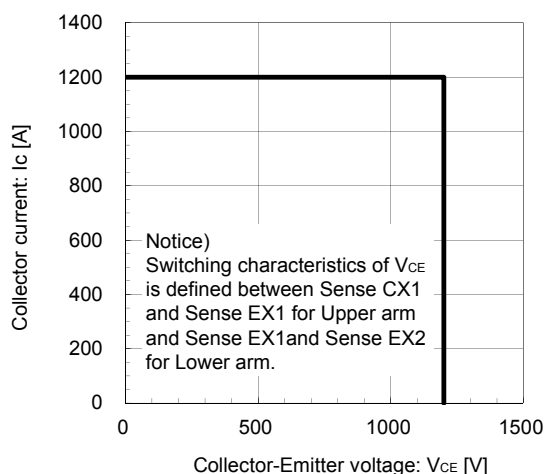
[INVERTER]

Switching loss vs. Gate resistance (typ.)
 $V_{CC}=600V, I_c=600A, V_{GE}=\pm 15V, T_j=125^\circ C, 150^\circ C$



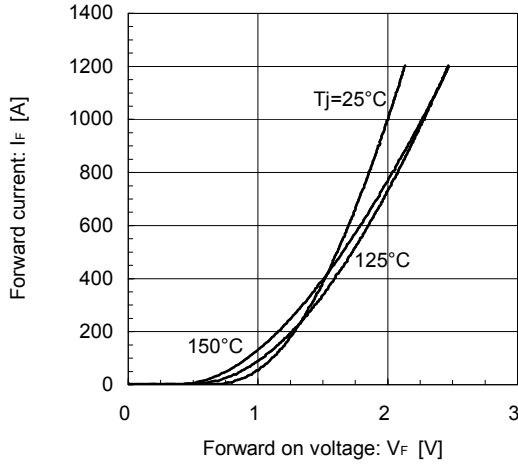
[INVERTER]

Reverse bias safe operating area (max.)
 $+V_{GE}=15V, -V_{GE}=15V, R_g=0.62\Omega, T_j=150^\circ C$



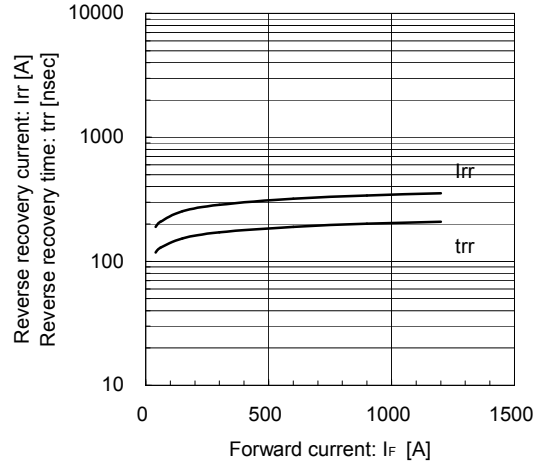
[INVERTER]

Forward Current vs. Forward Voltage (typ.)
chip



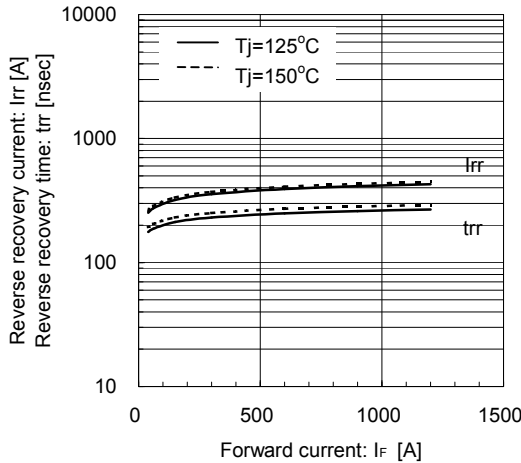
[INVERTER]

Reverse Recovery Characteristics (typ.)
V_{CC}=600V, V_{GE}=±15V, R_G=0.62Ω, T_J=25°C

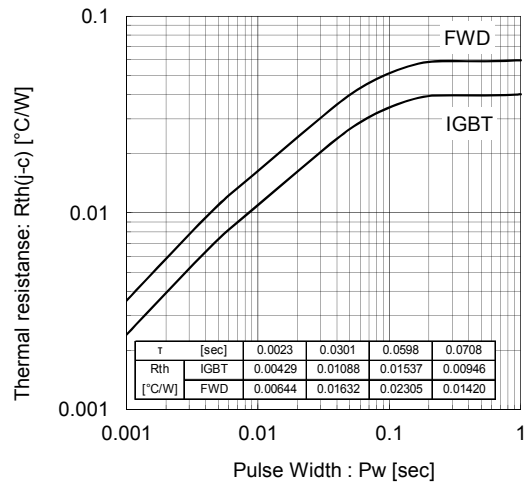


[INVERTER]

Reverse Recovery Characteristics (typ.)
V_{CC}=600V, V_{GE}=±15V, R_G=0.62Ω, T_J=125°C, 150°C

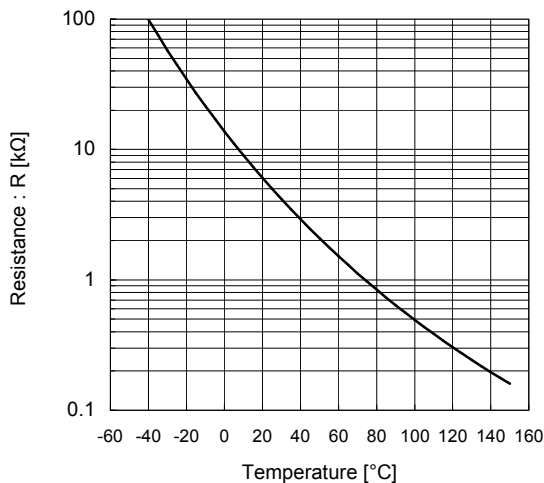


Transient Thermal Resistance (max.)

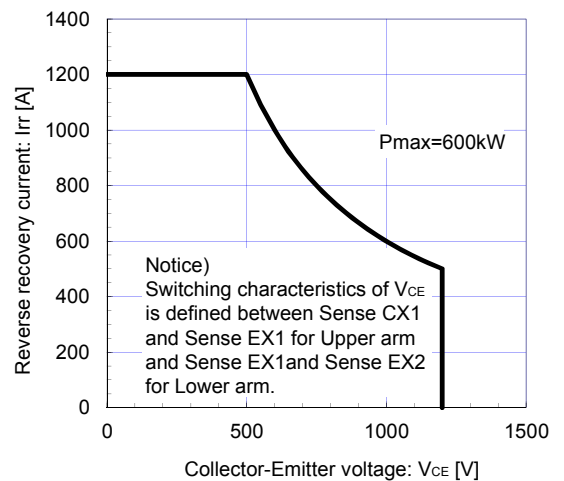


[THERMISTOR]

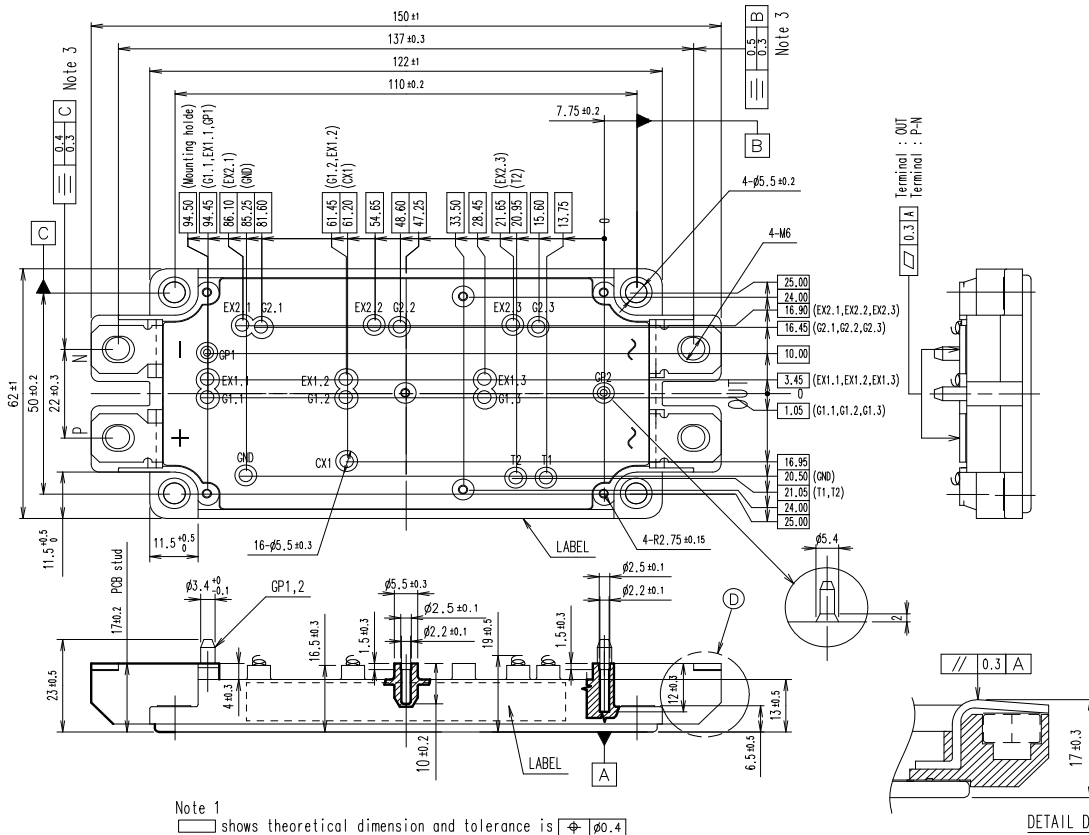
Temperature characteristic (typ.)



FWD safe operating area (max.)
T_J=150°C



Outline Drawings (Unit : mm)



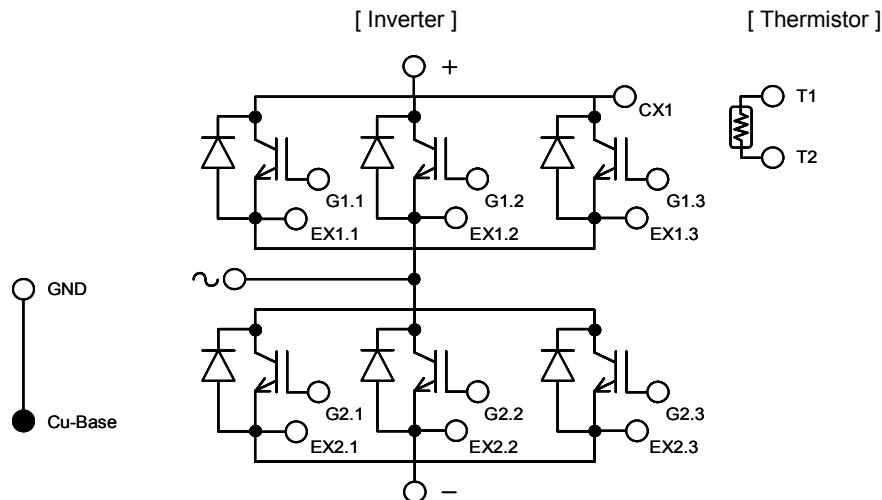
Note 1
 [Symbol] shows theoretical dimension and tolerance is $\pm \phi 0.4$

Note 2
 Rule for PCB
 · Guide pin hole : $\phi 4.0 \pm 0.1$
 · Guide pin distance : 94.45 ± 0.1
 · Spring contact pad : $\phi 3.8 \pm 0.2$
 · Position tol.pad : $\pm \phi 0.4$

Weight: 300g (typ.)

Note 3
 [Symbol] [Symbol] [Symbol]
 Upper value : Terminal hole center
 Lower value : Nut hole
 (Including margin of the nut position.)

Equivalent circuit



WARNING

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